

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name, I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled ERROR CORRECTION CIRCUIT AND ERROR CORRECTION METHOD, the specification of which is attached hereto unless the following box is checked: was filed on 13/05/99 as United States Application Number or PCT International Application Number 09/311,394 and was amended on____ (if applicable). I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56. I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s) Priority Not Claimed 10-150533 Japan 13/05/1998 (Number) (Country) (Day/Month/Year Filed) 10-202364 Japan 16/07/1998 (Numb r) (Country) (Day/Month/Year Filed) I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. (Application Number) (Filing Date) (Application Number) (Filing Date) I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of

any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

)	(Filing Date)	(Status - pate	ented, pending, abandoned)
(Application Number)	(Filing Date)	(Status - pate	ented, pending, abandoned	
POWER OF AT agent(s) to pros	secute this appl	named inventor, I ication and transac	hereby appoin at all business in	at the following atto In the Patent and Tra	rney(s) and/o demark Office
Paul F. Prestia Allan Ratner Andrew L. Ney Kenneth N. Nigon Kevin R. Casey Benjamin E. Leace James C. Simmons	Reg.No. 23,031 Reg.No. 19,717 Reg.No. 20,300 Reg.No. 31,549 Reg.No. 32,117 Reg.No. 33,412 Reg.No. 24,842	Lawrence E. Ashery Robert L. Andersen Christopher R. Lewis Louis W. Beardell, Jr. Rocco L. Adomato Jacques L. Etkowicz Eric A. Dichter	Reg.No. 34,515 Reg.No. 25,771 Reg.No. 36,201 Reg.No. 40,506 Reg.No. 40,480 Reg.No. 41,738 Reg.No. 41,708	Mark J. Marcelli Joshua L. Cohen Christopher J. Dervishian Jack J. Jankovitz	Reg.No. 36,593 Reg.No. 38,040 Reg.No. 42,480 Reg.No. 42,690
	ia, Suite 301, On			Valley Forge, PA 194	82-0980
statements ma statements wer are punishable	de on informa e made with th by fine or imp d that such wi	tion and belief ar e knowledge that orisonment, or both	e believed to willful false s n, under Sectio	on knowledge are true; be true; and furthestatements and the n 1001 of Title 18 dize the validity of the statements.	er that these like so made of the United
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Fifth inventor's signature		Date	
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Sixth inventor's signature		D .	
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